### **Features**

- Six High-side and Six Low-side Drivers
- . Outputs Freely Configurable as Switch, Half Bridge or H-bridge
- Capable to Switch all Kinds of Loads such as DC Motors, Bulbs, Resistors, Capacitors and Inductors
- 0.6 A Continuous Current per Switch
- Low-side:  $R_{DSon}$  < 1.5  $\Omega$  versus Total Temperature Range
- High-side:  $R_{DSon}$  < 2.0  $\Omega$  versus Total Temperature Range
- Very Low Quiescent Current Is < 20 µA in Standby Mode</li>
- Outputs Short-circuit Protected
- Overtemperature Prewarning and Protection
- Undervoltage Protection
- Various Diagnosis Functions such as Shorted Output, Open Load, Overtemperature and Power Supply Fail
- Serial Data Interface
- Operation Voltage up to 40 V
- Daisy Chaining Possible
- SO28 Power Package

# **Description**

The T6816 is a fully protected driver interface designed in 0.8 µm BCDMOS technology. It is especially suitable for truck or bus applications and the industrial 24-V supply. It controls up to 12 different loads via a 16-bit dataword.

Each of the six high-side and six low-side drivers is capable to drive currents up to 600 mA. The drivers are freely configurable and can be controlled separately from a standard serial data interface. Therefore, all kinds of loads such as bulbs, resistors, capacitors and inductors can be combined. The IC is also designed to easily build H-bridges to drive DC motors in motion-control applications.

Protection is guaranteed in terms of short-circuit conditions, overtemperature and undervoltage. Various diagnosis functions and a very low quiescent current in standby mode open a wide range of applications.

Overvoltage protection is matched to the requirements of the 24-V industrial voltage and the 24-V automotive supply. Automotive qualification referring to conducted interferences, EMC protection and 2 kV ESD protection gives added value and enhanced quality for the exacting requirements of automotive applications.



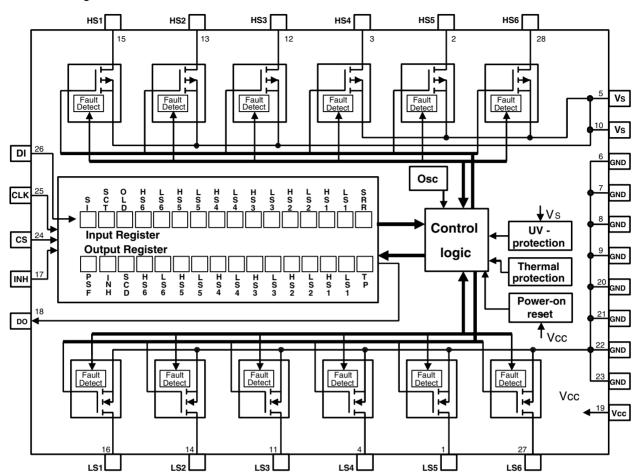
# 40-V Dual Hex Output Driver with Serial Input Control

T6816



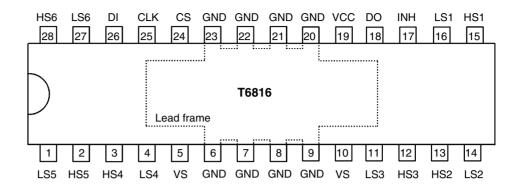


Figure 1. Block Diagram



# **Pin Configuration**

Figure 2. Pinning SO28



# **Pin Description**

Pin	Symbol	Function
1	LS5	Low-side driver output 5; Power-MOS open drain with internal reverse diode; short-circuit protection; diagnosis for short and open load
2	HS5	High-side driver output 5; Power-MOS open drain with internal reverse diode; short-circuit protection; diagnosis for short and open load
3	HS4	High-side driver output 4; see Pin 2
4	LS4	Low-side driver output 4; see Pin 1
5	VS	Power supply output stages HS4, HS5, HS6, internal supply; external connection to Pin 10 necessary
6, 7, 8, 9	GND	Ground; reference potential; internal connection to Pin 20 - 23; cooling tab
10	VS	Power supply output stages HS1, HS2 and HS3
11	LS3	Low-side driver output 3; see Pin 1
12	HS3	High-side driver output 3; see Pin 2
13	HS2	High-side driver output 2; see Pin 2
14	LS2	Low-side driver output 2; see Pin 1
15	HS1	High-side driver output 1; see Pin 2
16	LS1	Low-side driver output 1; see Pin 1
17	INH	Inhibit input; 5 V logic input with internal pull down; low = standby, high = normal operating
18	DO	Serial data output; 5 V CMOS logic level tri-state output for output (status) register data; sends 16-bit status information to the $\infty$ C (LSB is transferred first). Output will remain tri-stated unless device is selected by CS = low, therefore, several ICs can operate on one data output line only.
19	VCC	Logic supply voltage (5 V)
20, 21, 22, 23	GND	Ground; see Pin 6 – 9
24	CS	Chip select input; 5 V CMOS logic level input with internal pull up; low = serial communication is enabled, high = disabled
25	CLK	Serial clock input; 5 V CMOS logic level input with internal pull down; controls serial data input interface and internal shift register (f <sub>max</sub> = 2 MHz)
26	DI	Serial data input; 5 V CMOS logic level input with internal pull down; receives serial data from the control device; DI expects a 16-bit control word with LSB being transferred first
27	LS6	Low-side driver output 6; see Pin 1
28	HS6	High-side driver output 6; see Pin 2





# **Functional Description**

# **Serial Interface**

Data transfer starts with the falling edge of the CS signal. Data must appear at DI synchronized to CLK and are accepted on the falling edge of the CLK signal. LSB (bit 0, SRR) has to be transferred first. Execution of new input data is enabled on the rising edge of the CS signal. When CS is high, Pin DO is in tri-state condition. This output is enabled on the falling edge of CS. Output data will change their state with the rising edge of CLK and stay stable until the next rising edge of CLK appears. LSB (bit 0, TP) is transferred first.

Figure 3. Data Transfer Input Data Protocol

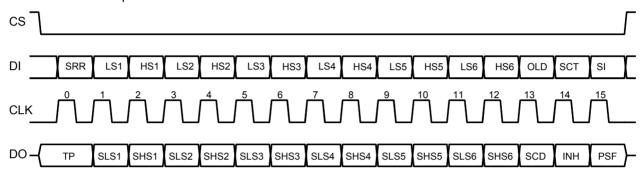


Table 1. Input Data Protocol

Bit	Input Register	Function
0	SRR	Status register reset (high = reset; the bits PSF, SCD and overtemperature shutdown in the output data register are set to low)
1	LS1	Controls output LS1 (high = switch output LS1 on)
2	HS1	Controls output HS1 (high = switch output HS1 on)
3	LS2	See LS1
4	HS2	See HS1
5	LS3	See LS1
6	HS3	See HS1
7	LS4	See LS1
8	HS4	See HS1
9	LS5	See LS1
10	HS5	See HS1
11	LS6	See LS1
12	HS6	See HS1

Table 1. Input Data Protocol (Continued)

Bit	Input Register	Function
13	OLD	Open load detection (low = on)
14	SCT	Programmable time delay for short circuit (shutdown delay high/ low = 12 ms/1.5 ms
15	SI	Software inhibit; low = standby, high = normal operation (data transfer is not affected by standby function because the digital part is still powered)

Table 2. Output Data Protocol

Table 2	Output Data Prote	0001
Bit	Output (Status) Register	Function
0	TP	Temperature prewarning: high = warning (overtemperature shut-down see remark below)
1	Status LS1	Normal operation: high = output is on, low = output is off Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched off)
2	Status HS1	Normal operation: high = output is on, low = output is off Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched off)
3	Status LS2	Description see LS1
4	Status HS2	Description see HS1
5	Status LS3	Description see LS1
6	Status HS3	Description see HS1
7	Status LS4	Description see LS1
8	Status HS4	Description see HS1
9	Status LS5	Description see LS1
10	Status HS5	Description see HS1
11	Status LS6	Description see LS1
12	Status HS6	Description see HS1
13	SCD	Short circuit detected: set high, when at least one output is switched off by a short circuit condition
14	INH	Inhibit: this bit is controlled by software (bit SI in input register) and hardware inhibit (Pin 17). High = standby, low = normal operation
15	PSF	Power supply fail: undervoltage at Pin VS detected

Note: Bit 0 to 15 = high: overtemperature shutdown

Table 3. Status of the Input Register after Power on Reset

Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
(SI)	(SCT)	(OLD)	(HS6)	(LS6)	(HS5)	(LS5)	(HS4)	(LS4)	(HS3)	(LS3)	(HS2)	(LS2)	(HS1)	(LS1)	(SRR)
Н	Н	Н	L	L	L	L	L	L	L	L	L	L	L	L	





# **Power Supply Fail**

In case of undervoltage at Pin VS, an internal timer is started. When the undervoltage delay time ( $t_{dUV}$ ) programmed by the SCT bit is reached, the power supply fail bit (PSF) in the output register is set and all outputs are disabled. When normal voltage is present again, the outputs are enabled immediately. The PSF bit remains high until it is reset by the SRR bit in the input register.

### **Open-load Detection**

If the open-load detection bit (OLD) is set to low, a pull-up current for each high-side switch and a pull-down current for each low-side switch is turned on (open-load detection current  $I_{HS1-6}$ ,  $I_{LS1-6}$ ). If  $V_{VS}-V_{HS1-6}$  or  $V_{LS1-6}$  is lower than the open-load detection threshold (open-load condition), the corresponding bit of the output in the output register is set to high. Switching on an output stage with OLD bit set to low disables the open-load function for this output.

# Overtemperature Protection

If the junction temperature exceeds the thermal prewarning threshold,  $T_{jPW \, set}$ , the temperature prewarning bit (TP) in the output register is set. When the temperature falls below the thermal prewarning threshold,  $T_{jPW \, reset}$ , the bit TP is reset. The TP bit can be read without transferring a complete 16-bit data word: with CS = high to low, the state of TP appears at Pin DO. After the microcontroller has read this information, CS is set high and the data transfer is interrupted without affecting the state of the input and output registers.

If the junction temperature exceeds the thermal shutdown threshold,  $T_{j \text{ switch off}}$ , the outputs are disabled and all bits in the output register are set high. The outputs can be enabled again when the temperature falls below the thermal shutdown threshold,  $T_{j \text{ switch on}}$ , and when a high has been written to the SRR bit in the input register. Thermal prewarning and shutdown threshold have hysteresis.

### **Short-circuit Protection**

The output currents are limited by a current regulator. Current limitation takes place when the overcurrent limitation and shutdown threshold ( $I_{HS1-6}$ ,  $I_{LS1-6}$ ) are reached. Simultaneously, an internal timer is started. The shorted output is disabled when during a permanent short the delay time ( $t_{dSd}$ ) programmed by the short-circuit timer bit (SCT) is reached. Additionally, the short-circuit detection bit (SCD) is set. If the temperature prewarning bit TP in the output register is set during a short, the shorted output is disabled immediately and SCD bit is set. By writing a high to the SRR bit in the input register, the SCD bit is reset and the disabled outputs are enabled.

### Inhibit

There are two ways to inhibit the T6816:

- 1. Set bit SI in the input register to zero
- 2. Switch Pin 17 (INH) to 0 V

In both cases, all output stages are turned off but the serial interface stays active. The output stages can be activated again by bit SI = 1 or by Pin 17 (INH) switched back to 5 V.

# **Absolute Maximum Ratings**

All values refer to GND pins

Parameter	Symbol	Value	Unit
Supply voltage Pins 5, 10	V <sub>VS</sub>	-0.3 to +40	V
Supply voltage tt0.5 s; I <sub>S</sub> u-2 A Pins 5, 10	V <sub>VS</sub>	-1	V
Supply voltage difference IV <sub>S_Pin5</sub> - V <sub>S_Pin10</sub> I	DV <sub>VS</sub>	150	mV
Supply current Pins 5, 10	I <sub>vs</sub>	1.4	Α
Supply current t < 200 ms Pins 5, 10	I <sub>vs</sub>	2.6	Α
Logic supply voltage Pin 19	V <sub>vcc</sub>	-0.3 to +7	V
Input voltage Pin 17	V <sub>INH</sub>	-0.3 to +17	V
Logic input voltage Pins 24 to 26	$V_{DI,}V_{CLK,}V_{CS}$	-0.3 to V <sub>VCC</sub> +0.3	V
Logic output voltage Pin 18	V <sub>DO</sub>	-0.3 to V <sub>VCC</sub> +0.3	V
Input current Pins 17, 24 to 26	I <sub>INH,</sub> I <sub>DI,</sub> I <sub>CLK,</sub> I <sub>CS</sub>	-10 to +10	mA
Output current Pin 18	I <sub>DO</sub>	-10 to +10	mA
Output current Pins 1 to 4, 11 to 16, Pins 27 and 28	I <sub>LS1 to</sub> I <sub>LS6</sub> I <sub>HS1 to</sub> I <sub>HS6</sub>	Internal limited, see output specification	
Reverse conducting current Pins 2, 3, 12, 13, 15, (t <sub>Pulse</sub> = 150 ms) 28 towards Pins 5, 10	I <sub>HS1 to</sub> I <sub>HS6</sub>	17	А
Junction temperature range	T <sub>j</sub>	-40 to +150	°C
Storage temperature range	T <sub>STG</sub>	-55 to +150	°C

# **Thermal Resistance**

All values refer to GND pins

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Junction - pin	Measured to GND Pins 6 to 9 and 20 to 23	$R_{thJP}$			25	K/W
Junction ambient		$R_{\text{thJA}}$			65	K/W

# **Operating Range**

All values refer to GND pins

Parameter	Test Conditions	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	Pins 5, 10	V <sub>VS</sub>	$V_{UV}^{(1)}$		40	V
Logic supply voltage	Pin 19	V <sub>VCC</sub>	4.5	5	5.5	V
Logic input voltage	Pin 17, 24 to 26	$V_{\text{INH,}} V_{\text{DI,}} $ $V_{\text{CLK,}} V_{\text{CS}}$	-0.3		V <sub>VCC</sub>	V
Serial interface clock frequency	Pin 25	f <sub>CLK</sub>			2	MHz
Junction temperature range		T <sub>j</sub>	-40		150	°C

Note: 1. Threshold for undervoltage detection.



# **Noise and Surge Immunity**

Parameter	Test Conditions	Value
Conducted interferences	ISO 7637-1	Level 4 (1)
Interference Suppression	VDE 0879 Part 2	Level 5
ESD (Human Body Model)	MIL-STD-883D Method 3015.7	2 kV
ESD (Machine Model)	EOS/ESD - S 5.2	150 V

Note: 1. Test pulse 5: V<sub>Smax</sub> = 40 V

# **Electrical Characteristics**

7.5 V <  $V_{VS}$  < 40 V; 4.5 V <  $V_{VCC}$  < 5.5 V; INH = High; -40°C <  $T_j$  < 150°C; unless otherwise specified, all values refer to GND pins.

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
1	Current Consumption	<u> </u>							
1.1	Quiescent current (VS)	V <sub>VS</sub> < 28 V, INH or bit SI = lo	5, 10	I <sub>VS</sub>			40	μΑ	А
1.2	Quiescent current (VCC)	$4.5 \text{ V} < \text{V}_{\text{VCC}} < 5.5 \text{ V},$ INH or bit SI = low	19	I <sub>vcc</sub>			20	μΑ	А
1.3	Supply current (VS)	V <sub>VS</sub> < 28 V normal operating, all output stages off,	5, 10	I <sub>VS</sub>		0.8	1.2	mA	А
1.4	Supply current (VS)	V <sub>VS</sub> < 28 V normal operating, all output stages on, no load	5, 10	I <sub>VS</sub>			10	mA	А
1.5	Supply current (VCC)	4.5 V < V <sub>VCC</sub> < 5.5 V, normal operating Pin	19	I <sub>VCC</sub>			150	μA	А
2	Internal Oscillator Fre	quency							
2.1	Frequency (timebase for delay timers)			f <sub>osc</sub>	19		45	kHz	А
3	Undervoltage Detection	on, Power-on Reset			•	•	•	•	·
3.1	Power–on reset threshold		19	$V_{VCC}$	3.4	3.9	4.4	V	Α
3.2	Power–on reset delay time	After switching on V <sub>VCC</sub>	19	t <sub>dPor</sub>	30	95	160	μs	А
3.3	Undervoltage detection threshold		5, 10	V <sub>UV</sub>	5.5		7.0	V	А
3.4	Undervoltage detection hysteresis		5, 10	$\Delta V_{UV}$		0.4		V	А
3.5	Undervoltage detection delay		5, 10	t <sub>dUV</sub>	7		21	ms	А
4	Thermal Prewarning a	and Shutdown							
4.1	Thermal prewarning		17	T <sub>jPWset</sub>	125	145	165	°C	Α
4.2	Thermal prewarning		17	T <sub>jPWreset</sub>	105	125	145	°C	Α

<sup>\*)</sup> Type means: A =100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. Delay time between rising edge of CS after data transmission and switch on output stages to 90% of final level

# **Electrical Characteristics (Continued)**

 $7.5~V < V_{VS} < 40~V$ ;  $4.5~V < V_{VCC} < 5.5~V$ ; INH = High;  $-40^{\circ}C < T_{j} < 150^{\circ}C$ ; unless otherwise specified, all values refer to GND pins.

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
4.3	Thermal prewarning hysteresis			DT <sub>jPW</sub>		20		K	А
4.4	Thermal shutdown		17	T <sub>j switch off</sub>	150	170	190	°C	Α
4.5	Thermal shutdown		17	T <sub>j switch on</sub>	130	150	170	°C	Α
4.6	Thermal shutdown hysteresis			DT <sub>j switch off</sub>		20		K	Α
4.7	Ratio thermal shutdown/thermal prewarning			T <sub>j switch off/</sub> T <sub>jPW set</sub>	1.05	1.17			А
4.8	Ratio thermal shutdown/thermal prewarning			T <sub>j switch on/</sub> T <sub>jPW reset</sub>	1.05	1.2			Α
5	Output Specification	(LS1 - LS6, HS1 - HS6)	7.5 V < V	<sub>VS</sub> < 40 V					
5.1	On resistance	I <sub>Out</sub> = 600 mA	1, 4, 11, 14, 16, 27	R <sub>DS OnL</sub>			1.5	Ω	A
5.2	On resistance	I <sub>Out</sub> = -600 mA	2, 3, 12, 13, 15, 28	R <sub>DS OnH</sub>			2.0	Ω	A
5.3	Output clamping voltage	I <sub>LS1-6</sub> = 50 mA	1, 4, 11, 14, 16, 27	V <sub>LS1-6</sub>	40		60	V	А
5.4	Output leakage current	V <sub>LS1-6</sub> = 40 V all output stages off	1, 4, 11, 14, 16, 27	I <sub>LS1-6</sub>			10	μА	A
5.5	Output leakage current	V <sub>HS1-6</sub> = 0 V all output stages off	2, 3, 12, 13, 15, 28	I <sub>HS1-6</sub>	-10			μА	A
5.7	Inductive shutdown energy		1-4, 11-16 27, 28	W <sub>outx</sub>			15	mJ	D
5.8	Output voltage edge steepness		1-4, 11-16 27, 28	$\frac{dV_{LS1-6}/dt}{dV_{HS1-6}/dt}$	50	200	400	mV/μs	Α
5.9	Overcurrent limitation and shutdown threshold		1, 4, 11,14 16, 27	I <sub>LS1-6</sub>	650	950	1250	mA	Α

<sup>\*)</sup> Type means: A =100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. Delay time between rising edge of CS after data transmission and switch on output stages to 90% of final level





# **Electrical Characteristics (Continued)**

7.5 V <  $V_{VS}$  < 40 V; 4.5 V <  $V_{VCC}$  < 5.5 V; INH = High; -40°C <  $T_j$  < 150°C; unless otherwise specified, all values refer to GND pins.

Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
Overcurrent limitation and shutdown threshold		2, 3, 12,13 15, 28	I <sub>HS1-6</sub>	-1250	-950	-650	mA	А
Overcurrent shutdown delay time	Input register bit 14 (SCT) = low		t <sub>dSd</sub>	1.0	1.5	2.0	ms	А
Open load detection current	Input register bit 13 (OLD) =low, output off	1, 4, 11,14 16, 27	I <sub>LS1-6</sub>	60		200	μА	А
Open load detection current	Input register bit 13 (OLD) =low, output off	2, 3, 12, 13 15, 28	I <sub>HS1-6</sub>	-150		-30	μА	А
Open load detection current ratio			I <sub>LS1-6</sub> /I <sub>HS1-</sub>	1.2				А
Open load detection threshold	Input register bit 13 (OLD) =low, output off	1, 4, 11,14 16, 27	V <sub>LS1-6</sub>	0.6		4	V	А
Open load detection threshold	Input register bit 13 (OLD) =low, output off	2, 3, 12, 13 15, 28	V <sub>VS-</sub> V <sub>HS1-6</sub>	0.6		4	V	А
Output switch on delay 1)	$R_{Load} = 1 \text{ k}\Omega$		t <sub>don</sub>			0.5	ms	А
Output switch off delay 1)	$R_{Load} = 1 \text{ k}\Omega$		t <sub>doff</sub>			1	ms	А
Inhibit Input		I.	I	I.		1	1	1
Input voltage low level threshold		17	V <sub>IL</sub>	0.3- V <sub>VCC</sub>			V	А
Input voltage high level threshold		17	V <sub>IH</sub>			0.7- V <sub>VCC</sub>	V	А
Hysteresis of input voltage		17	$\Delta V_{I}$	100		700	mV	А
Pull-down current	$V_{INH} = V_{VCC}$	17	I <sub>PD</sub>	10		80	μΑ	Α
Serial Interface - Logic	c Inputs DI, CLK, CS					'		
Input voltage low- level threshold		24-26	V <sub>IL</sub>	0.3- V <sub>VCC</sub>			V	А
Input voltage high- level threshold		24-26	V <sub>IH</sub>			0.7- V <sub>VCC</sub>	V	Α
Hysteresis of input voltage		24-26	DVI	50		500	mV	Α
Pull-down current Pin DI, CLK	$V_{DI}$ , $V_{CLK} = V_{VCC}$	25, 26	I <sub>PDSI</sub>	2		50	μА	Α
Pull-up current Pin CS	V <sub>CS</sub> = 0 V	24	I <sub>PUSI</sub>	-50		-2	μА	Α
	Overcurrent limitation and shutdown threshold Overcurrent shutdown delay time Open load detection current Open load detection current ratio Open load detection current ratio Open load detection threshold Open load detection threshold Open load detection threshold Open load detection threshold Output switch on delay 1) Inhibit Input Input voltage low level threshold Input voltage high level threshold Hysteresis of input voltage Pull-down current Serial Interface - Logic Input voltage low-level threshold Input voltage high-level threshold Hysteresis of input voltage Pull-down current Pin DI, CLK Pull-up current	Overcurrent limitation and shutdown threshold       Input register bit 13 (OLD) = low, output off         Open load detection current       Input register bit 13 (OLD) = low, output off         Open load detection current       Input register bit 13 (OLD) = low, output off         Open load detection current ratio       Input register bit 13 (OLD) = low, output off         Open load detection threshold       Input register bit 13 (OLD) = low, output off         Open load detection threshold       Input register bit 13 (OLD) = low, output off         Output switch on delay 1) $R_{Load} = 1 \text{ k}\Omega$ Output switch off delay 1) $R_{Load} = 1 \text{ k}\Omega$ Input voltage low level threshold $R_{Load} = 1 \text{ k}\Omega$ Input voltage low level threshold $R_{Load} = 1 \text{ k}\Omega$ Hysteresis of input voltage $R_{Load} = 1 \text{ k}\Omega$ Pull-down current $V_{INH} = V_{VCC}$ Serial Interface - Logic Inputs DI, CLK, CS         Input voltage low-level threshold       Input voltage high-level threshold         Hysteresis of input voltage $V_{INH} = V_{VCL} = V_{VCC}$ Pull-down current Pin DI, CLK $V_{INH} = V_{VCL} = V_{VCC}$ Pull-up current $V_{INH} = V_{VCL} = V_{VCC}$	Overcurrent limitation and shutdown threshold       2, 3, 12,13 15, 28         Overcurrent shutdown delay time       Input register bit 13 (OLD) = low, output off (OLD)	Overcurrent limitation and shutdown threshold       2, 3, 12,13 15, 28 $I_{HS1-6}$ Overcurrent shutdown delay time shutdown delay time       Input register bit 13 (OLD) = low, output off surrent       1, 4, 11,14 16, 27         Open load detection current       Input register bit 13 (OLD) = low, output off surrent ratio       2, 3, 12, 13 15, 28         Open load detection current ratio       Input register bit 13 (OLD) = low, output off surrent ratio       1, 4, 11, 14 16, 27         Open load detection current ratio       Input register bit 13 (OLD) = low, output off surrent ratio       1, 4, 11, 14 16, 27         Open load detection threshold       Input register bit 13 (OLD) = low, output off surrent	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Overcurrent limitation and shutdown hitneshold   Input register bit 13 (OLD) =low, output off threshold   Input voltage low-level threshold   Input	Overcurrent limitation and shutdown and shutdown function and shutdown delay time   Input register bit 14 (SCT) = low   Input register bit 13 (OLD) = low, output off current atio   Input register bit 13 (OLD) = low, output off current   Input voltage low level threshold   Input voltage light level threshold   Input voltage low l

<sup>\*)</sup> Type means: A =100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. Delay time between rising edge of CS after data transmission and switch on output stages to 90% of final level

# **Electrical Characteristics (Continued)**

 $7.5~V < V_{VS} < 40~V$ ;  $4.5~V < V_{VCC} < 5.5~V$ ; INH = High;  $-40^{\circ}C < T_{j} < 150^{\circ}C$ ; unless otherwise specified, all values refer to GND pins.

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Тур.	Max.	Unit	Type*
8	8 Serial Interface - Logic Output DO								
8.1	Output voltage low level	I <sub>OL</sub> = 3 mA	18	V <sub>DOL</sub>			0.5	V	Α
8.2	Output voltage high level	I <sub>OL</sub> = -2 mA	18	V <sub>DOH</sub>	V <sub>VCC</sub> - 0.7 V			V	Α
8.3	Leakage current (tri-state)	$V_{CS} = V_{VCC,}$ $0 V < V_{DO} < V_{VCC}$	18	I <sub>DO</sub>	-10		10	μΑ	А

<sup>\*)</sup> Type means: A =100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Notes: 1. Delay time between rising edge of CS after data transmission and switch on output stages to 90% of final level

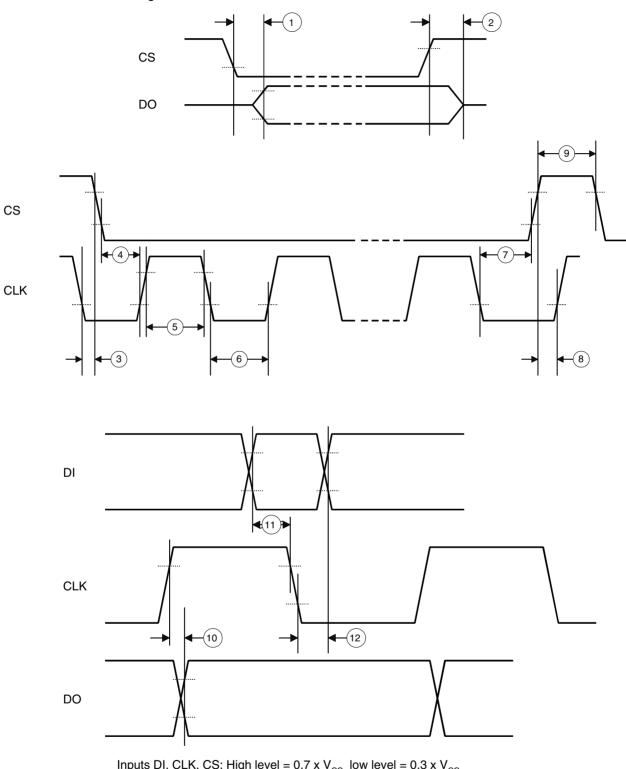
# **Serial Interface** — Timing

Parameters	Test Conditions	Timing Chart No.	Symbol	Min.	Тур.	Max.	Unit
DO enable after CS falling edge	C <sub>DO</sub> = 100 pF	1	t <sub>ENDO</sub>			200	ns
DO disable after CS rising edge	C <sub>DO</sub> = 100 pF	2	t <sub>DISDO</sub>			200	ns
DO fall time	C <sub>DO</sub> = 100 pF	_	t <sub>DOf</sub>			100	ns
DO rise time	C <sub>DO</sub> = 100 pF	_	t <sub>DOr</sub>			100	ns
DO valid time	C <sub>DO</sub> = 100 pF	10	t <sub>DOVal</sub>			200	ns
CS setup time		4	t <sub>CSSethl</sub>	225			ns
CS setup time		8	t <sub>CSSetlh</sub>	225			ns
CS high time	Input register Bit 14 (SCT) = high	9	t <sub>CSh</sub>	16			ms
CS high time	Input register Bit 14 (SCT) = low	9	t <sub>CSh</sub>	2			ms
CLK high time		5	t <sub>CLKh</sub>	225			ns
CLK low time		6	t <sub>CLKI</sub>	225			ns
CLK period time		_	t <sub>CLKp</sub>	500			ns
CLK setup time		7	t <sub>CLKSethl</sub>	225			ns
CLK setup time		3	t <sub>CLKSetlh</sub>	225			ns
DI setup time		11	t <sub>Diset</sub>	40			ns
DI hold time		12	t <sub>DIHold</sub>	40			ns



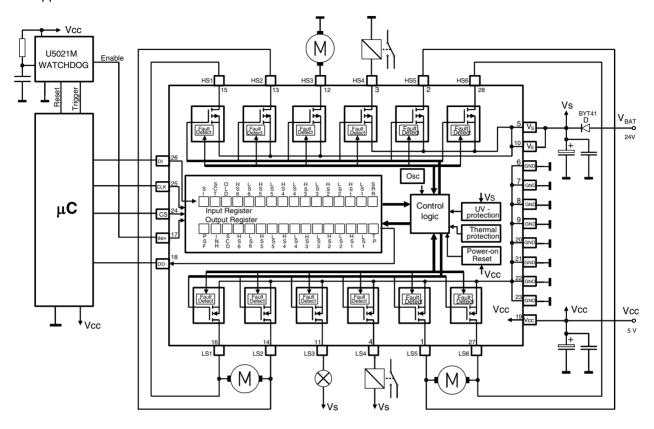


Figure 4. Serial Interface Timing with Chart Numbers



Inputs DI, CLK, CS: High level = 0.7 x  $V_{CC}$ , low level = 0.3 x  $V_{CC}$  Output DO: High level = 0.8 x  $V_{CC}$ , low level = 0.2 x  $V_{CC}$ 

Figure 5. Application Circuit



# **Application Notes**

It is strongly recommended to connect the blocking capacitors at  $V_{CC}$  and  $V_{S}$  as close as possible to the power supply and GND pins.

Recommended value for capacitors at V<sub>S</sub>:

electrolythic capacitor C > 22 µF in parallel with a ceramic capacitor C = 100 nF. Value for electrolytic capacitor depends on external loads, conducted interferences and reverse conducting current I<sub>HSX</sub> (see: Absolut Maximum Ratings).

Recommended value for capacitors at  $V_{CC}$ : electrolythic capacitor  $C>10~\mu F$  in parallel with a ceramic capacitor C=100~nF.

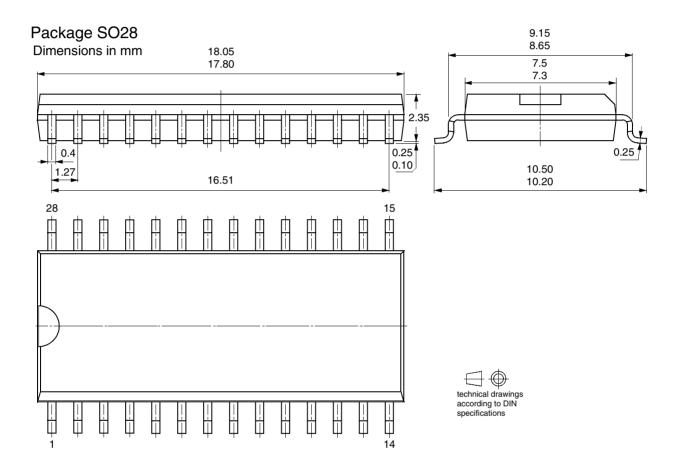
To reduce thermal resistance it is recommended to place cooling areas on the PCB as close as possible to GND pins.



# **Ordering Information**

Extended Type Number	Package	Remarks
T6816-TIQ	SO28	Power package, taped and reeled

# **Package Information**





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